

# CD54/74HC138, CD54/74HCT138, CD54/74HC238, CD54/74HCT238

Data sheet acquired from Harris Semiconductor

High-Speed CMOS Logic 3- to 8-Line Decoder/ Demultiplexer Inverting and Non-Inverting

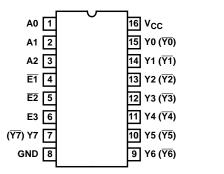
October 1997 - Revised May 2003

#### Features

- Select One Of Eight Data Outputs Active Low for 138, Active High for 238
- I/O Port or Memory Selector
- Three Enable Inputs to Simplify Cascading
- Typical Propagation Delay of 13ns at  $V_{CC} = 5V$ ,  $C_1 = 15pF$ ,  $T_{\Delta} = 25^{\circ}C$
- Fanout (Over Temperature Range)
  - Standard Outputs......10 LSTTL Loads
  - Bus Driver Outputs ...... 15 LSTTL Loads
- Wide Operating Temperature Range ... -55°C to 125°C
- Balanced Propagation Delay and Transition Times
- Significant Power Reduction Compared to LSTTL Logic ICs
- HC Types
  - 2V to 6V Operation
  - High Noise Immunity: N<sub>IL</sub> = 30%, N<sub>IH</sub> = 30% of V<sub>CC</sub> at V<sub>CC</sub> = 5V
- HCT Types
  - 4.5V to 5.5V Operation
  - Direct LSTTL Input Logic Compatibility,
     V<sub>IL</sub>= 0.8V (Max), V<sub>IH</sub> = 2V (Min)
  - CMOS Input Compatibility,  $I_I \le 1 \mu A$  at VOL, VOH

#### **Pinout**

CD54HC138, CD54HC138, CD54HC238, CD54HCT238
(CERDIP)
CD74HC138, CD74HC138, CD74HC1238
(PDIP, SOIC)
CD74HC238
(PDIP, SOIC, SOP, TSSOP)
TOP VIEW



Signal names in parentheses are for 'HC138 and 'HCT138.

#### Description

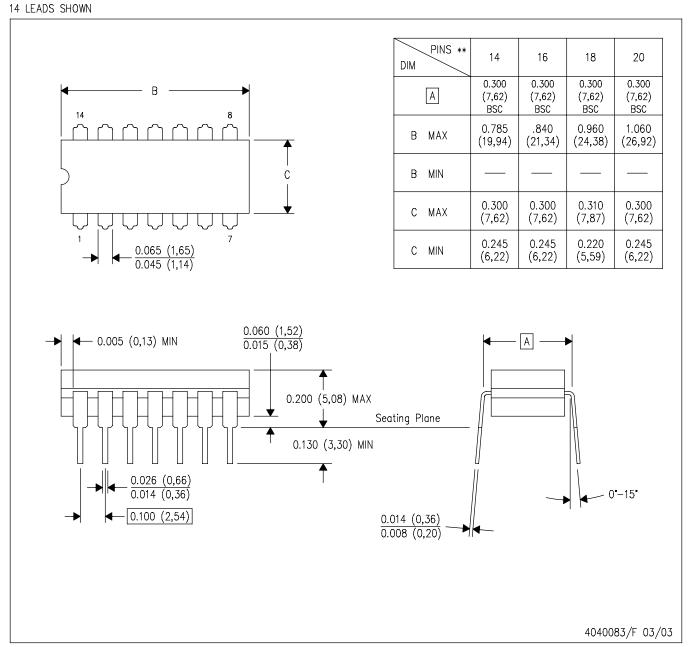
The 'HC138, 'HC238, 'HCT138, and 'HCT238 are high speed silicon gate CMOS decoders well suited to memory address decoding or data routing applications. Both circuits feature low power consumption usually associated with CMOS circuitry, yet have speeds comparable to low power Schottky TTL logic. Both circuits have three binary select inputs (A0, A1 and A2). If the device is enabled, these inputs determine which one of the eight normally high outputs of the HC/HCT138 series will go low or which of the normally low outputs of the HC/HCT238 series will go high.

Two active low and one active high enables ( $\overline{E1}$ ,  $\overline{E2}$ , and E3) are provided to ease the cascading of decoders. The decoder's 8 outputs can drive 10 low power Schottky TTL equivalent loads.

#### **Ordering Information**

PART NUMBER	TEMP. RANGE (°C)	PACKAGE
CD54HC138F3A	-55 to 125	16 Ld CERDIP
CD54HC238F3A	-55 to 125	16 Ld CERDIP
CD54HCT138F3A	-55 to 125	16 Ld CERDIP
CD54HCT238F3A	-55 to 125	16 Ld CERDIP
CD74HC138E	-55 to 125	16 Ld PDIP
CD74HC138M	-55 to 125	16 Ld SOIC
CD74HC138M96	-55 to 125	16 Ld SOIC
CD74HC238E	-55 to 125	16 Ld PDIP
CD74HC238M	-55 to 125	16 Ld SOIC
CD74HC238M96	-55 to 125	16 Ld SOIC
CD74HC238NSR	-55 to 125	16 Ld SOP
CD74HC238PW	-55 to 125	16 Ld TSSOP
CD74HC238PWR	-55 to 125	16 Ld TSSOP
CD74HCT138E	-55 to 125	16 Ld PDIP
CD74HCT138M	-55 to 125	16 Ld SOIC
CD74HCT138M96	-55 to 125	16 Ld SOIC
CD74HCT238E	-55 to 125	16 Ld PDIP
CD74HCT238M	-55 to 125	16 Ld SOIC

NOTE: When ordering, use the entire part number. The suffixes 96 and R denote tape and reel.



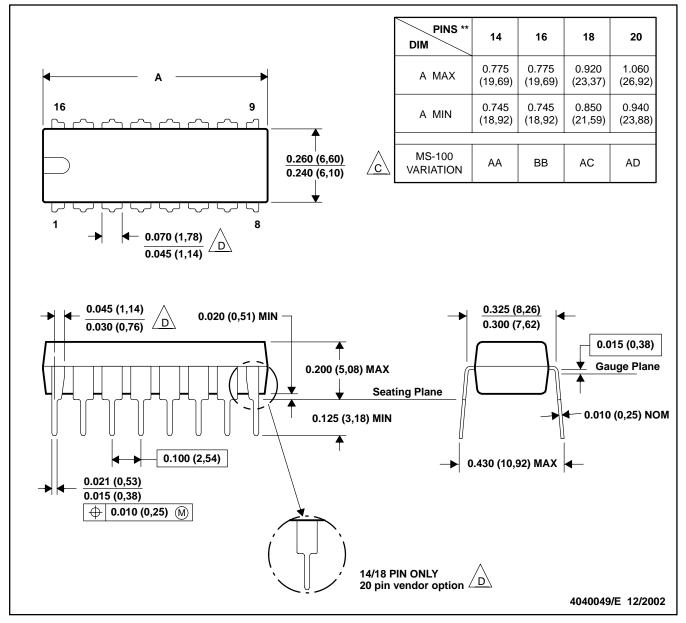
NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

#### N (R-PDIP-T\*\*)

#### 16 PINS SHOWN

#### PLASTIC DUAL-IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

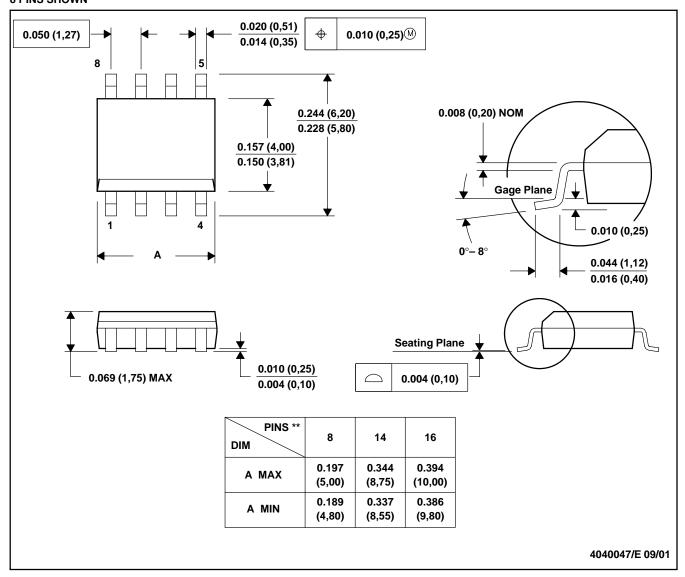
Falls within JEDEC MS-001, except 18 and 20 pin minimum body Irngth (Dim A).

The 20 pin end lead shoulder width is a vendor option, either half or full width.

#### D (R-PDSO-G\*\*)

#### PLASTIC SMALL-OUTLINE PACKAGE

#### **8 PINS SHOWN**



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).

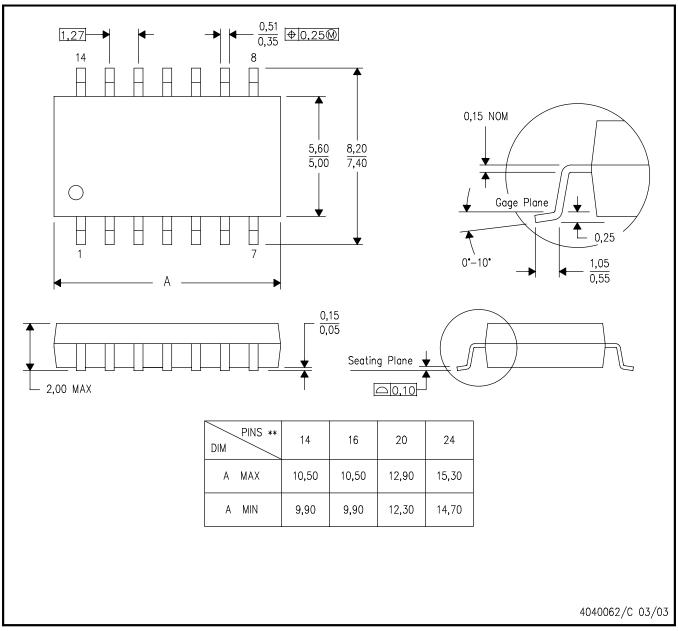
D. Falls within JEDEC MS-012

#### **MECHANICAL DATA**

### NS (R-PDSO-G\*\*)

## 14-PINS SHOWN

#### PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

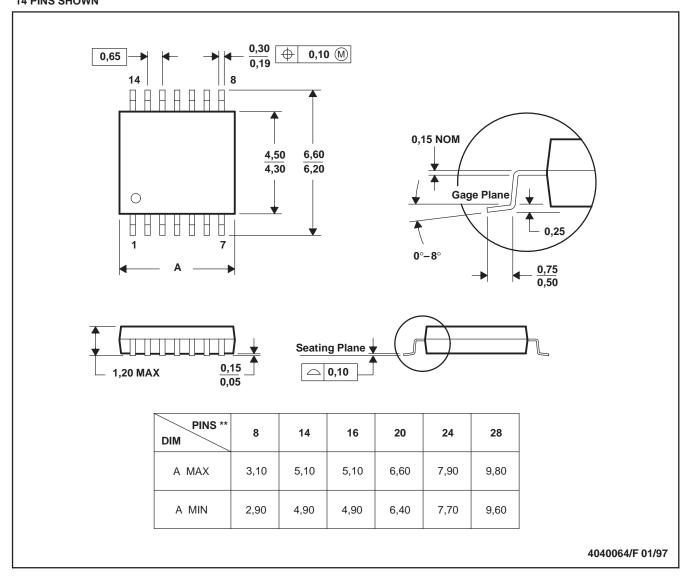
- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



#### PW (R-PDSO-G\*\*)

#### 14 PINS SHOWN

#### PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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